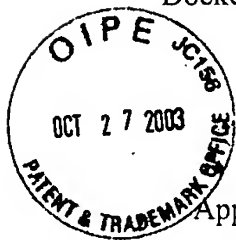


Docket No.: TOYAM83.001APC

Customer No.: 20,995



AMENDMENT / RESPONSE TRANSMITTAL

Applicant : Yamashita, et al.
App. No. : 10/019,753
Filed : March 5, 2002
For : LOW-HYGROSCOPICITY
LOW-BIREFRINGENCE
RESIN COMPOSITIONS,
MOLDING MATERIAL
OBTAINED THEREFROM,
SHEET OR FILM, AND
OPTICAL PART
Examiner : R.A. Lee
Art Unit : 1713

CERTIFICATE OF MAILING

I hereby certify that this correspondence and all marked attachments are being deposited with the United States Postal Service as first-class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on

October 24, 2003

(Date)

Che S. Chereskin

Che Swyden Chereskin, Ph.D., Reg. No. 41,466

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OCT 30 2003
TC 1700

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Transmitted herewith for filing in the above-identified application are the following enclosures:

(X) Amendment in 15 pages.

The fee has been calculated as shown below:

| FEE CALCULATION | | | | |
|--------------------|-------------|--------------|---------------|-------|
| FEE TYPE | | FEE CODE | CALCULATION | TOTAL |
| Total Claims | 29 - 30 = 0 | 1202 (\$18) | 0 x 18 = | \$0 |
| Independent Claims | 3 - 3 = 0 | 1201 (\$86) | 0 x 86 = | \$0 |
| 2 Month Extension | | 1252 (\$420) | | \$420 |
| | | | TOTAL FEE DUE | \$420 |

- (X) An extension of time is hereby requested by payment of the appropriate fee indicated above.
- (X) A check in the amount of \$420 is enclosed.
- (X) Return prepaid postcard.

Docket No.: TOYAM83.001APC

Customer No.: 20,995

- (X) Please charge any additional fees, including any fees for additional extension of time, or credit overpayment to Deposit Account No. 11-1410.

Che S. Chereskin

Che Swyden Chereskin, Ph.D.

Registration No. 41,466

Agent of Record

Customer No. 20,995

(949) 760-0404

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102403

TOYAM83:001APC

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Yamashita, et al.

Group Art Unit : 1713

Appl. No. : 10/019,753

Filed : March 5, 2002

For : LOW-HYGROSCOPICITY LOW-
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MATERIAL OBTAINED
THEREFROM, SHEET OR FILM,
AND OPTICAL PART

Examiner : Lee, Rip A.

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OCT 30 2003
TC 1700

AMENDMENT

United States Patent and Trademark Office
PO Box 1450,
Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action mailed June 11, 2003, Applicants respectfully request the Examiner to enter the following amendments and consider the following arguments.

10/29/2003 SSITHIB1 00000080 10019753

01 FC:1252

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